

#### **N-Channel Enhancement Mode MOSFET**

### **General Description**

The CMS9475 uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications.

#### **Features**

- RDS(ON)≤41mΩ @ VGS=10V
- RDS(ON)≤52mΩ @ VGS=4.5V
- Surface mount package.
- High Density Cell Design For Ultra Low On Resistance

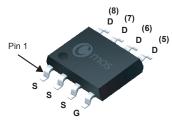
### **Product Summary**

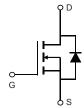
BVDSS	RDSON	ID
60V	41mΩ	6.5A

### **Applications**

- Inverter Switch
- Synchronous Rectifier
- Load Switch
- DC/DC Converter

### **SOP-8 Pin Configuration**





SOP-8

Туре	Package	Marking
CMS9475	SOP-8	CMS9475

### Absolute Maximum Ratings (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Rating	Units	
$V_{DS}$	Drain-Source Voltage	60	V	
$V_{GS}$	Gate-Source Voltage	±20	V	
I <sub>D</sub>	Continuous Drain Current	6.5	А	
I <sub>DM</sub>	Pulsed Drain Current	30	А	
P <sub>D</sub> @T <sub>A</sub> =25°C	Total Power Dissipation	3.7	W	
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	

## **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
$R_{ heta JA}$	Thermal Resistance, Junction-to-Ambient (PCB mounted)		62.5	°C/W



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## Electrical Characteristics ( $T_J=25$ °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS}$ =0 $V$ , $I_D$ =250 $\mu$ A	60			V
р	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =5.3A			41	mΩ
R <sub>DS(ON)</sub>		V <sub>GS</sub> =4.5V , I <sub>D</sub> =4.7A			52	
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{GS}$ = $V_{DS}$ , $I_D$ =250 $\mu$ A	1		3	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =60V , V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm 20V$ , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =15V , I <sub>D</sub> =5.3A		10		S
$Q_g$	Total Gate Charge	V <sub>DS</sub> =30V , V <sub>GS</sub> =10V , I <sub>D</sub> =5.3A		22		
Q <sub>gs</sub>	Gate-Source Charge			7.1		nC
$Q_{gd}$	Gate-Drain Charge			7.5		
$T_{d(on)}$	Turn-On Delay Time			13		
T <sub>r</sub>	Rise Time	$V_{DD}$ =30V , $V_{GEN}$ =10V , $R_L$ =6.8 $\Omega$ $R_G$ =1 $\Omega$ , $I_D$ =4.4A		25		ns
$T_{d(off)}$	Turn-Off Delay Time			40		115
T <sub>f</sub>	Fall Time			3.5		
C <sub>iss</sub>	Input Capacitance			930		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		72		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			80		

# Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
$V_{SD}$	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>S</sub> =2A			1.2	V

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